

2SK805

Silicon N-channel Power F-MOS FET

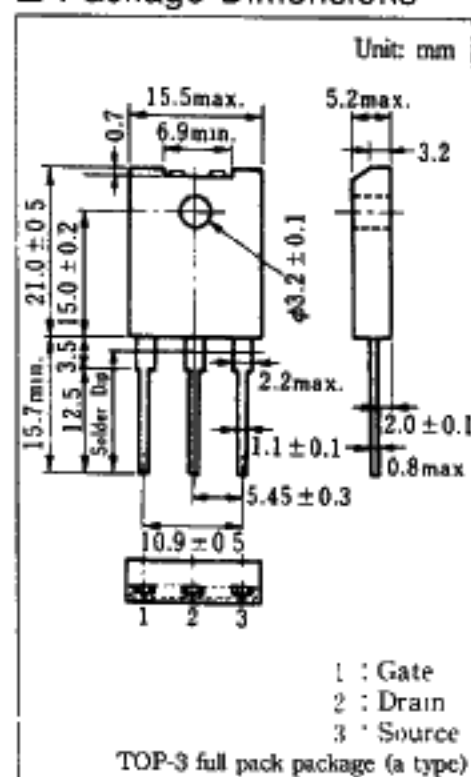
■ Features

- Low ON resistance $R_{DS(on)}$: $R_{DS(on)} = 0.12\Omega$ (typ.)
- High switching rate : $t_f = 120\text{ns}$ (typ.)
- No secondary breakdown
- High breakdown voltage

■ Application

- DC-DC converter
- No contact relay
- Solenoid drive
- Motor drive

■ Package Dimensions



■ Absolute Maximum Ratings (Tc=25°C)

Item	Symbol	Value	Unit
Drain-source voltage	V_{DS}	200	V
Gate-source voltage	V_{GS}	± 20	V
Drain current	DC	I_D	20
	Peak-to-peak value	I_{DP}	40
Power dissipation	Tc = 25°C	P_D	100
	Ta = 25°C		3.0
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

■ Electrical Characteristics (Tc=25°C)

Item	Symbol	Condition	min.	typ.	max.	Unit	
Drain current	I_{DSS}	$V_{DS} = 160\text{V}$, $V_{GS} = 0$			0.1	mA	
Gate-source current	I_{GSS}	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0$			± 1	μA	
Drain-source voltage	V_{DSS}	$I_D = 1\text{mA}$, $V_{GS} = 0$	200			V	
Gate threshold voltage	V_{th}	$V_{DS} = 10\text{V}$, $I_D = 1\text{mA}$	1		5	V	
Drain-source ON resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_D = 10\text{A}$		0.12	0.18	Ω	
Drain-source ON voltage	$V_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_{DS} = 20\text{A}$			3.7	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10\text{V}$, $I_D = 10\text{A}$	5.5	9.0		S	
Input capacitance	C_{iss}	$V_{DS} = 10\text{V}$, $V_{GS} = 0$, $f = 1\text{MHz}$		1480		pF	
Output capacitance	C_{oss}				490		pF
Reverse transfer capacitance	C_{rss}				250		pF
Turn-on time	t_{on}	$V_{GS} = 10\text{V}$, $I_D = 10\text{A}$ $V_{DD} = 100\text{V}$, $R_L = 10\Omega$		100		ns	
Fall time	t_f				120		ns
Delay time	t_d (off)				300		ns

